Not	ificat	ion Numbe	r:	2016	080	1000		Notif	ica	tion Date:	08/09/2016	
Title	e:	Datasheet f	or TPS6	51085-	Q1							
Cus	tome	r Contact:	PCN /	Manager						S		
Cha	nge 1	Гуре:			•		•	-				
Assembly Site					☐ Design ☐ Wa				Wafer Bum	Wafer Bump Site		
	Assembly Process			□ Data Sheet □ Data Sheet					Wafer Bump Material			
	Assembly Materials					Part number change				Wafer Bump Process		
Щ	Mechanical Specification				Щ	Test Site			<u></u>	Wafer Fab Site		
Packing/Shipping/Labeling					Test Process			Щ.	Wafer Fab Materials			
Notification Details Wafer Fab Process												
Des	cript	ion of Chan	ae:		140	Julication	Detai	15				
		truments In		ted is	ann	ouncing an i	nformati	ion only	no	tification.		
										story below:		
	•		,	•								
										TI II	EXAS ISTRUMENTS	
TPS	61085-	Q1									OTTOMET 115	
SLVSA	AI9A-SEF	PTEMBER 2010-RE	/ISED JULY	/ 2016							www.ti.com	
Cha	nges fro	om Original (Se	otember	2010) to	Revi	sion A					Page	
. /	Added <i>E</i>	SD Ratings table	e. Therma	al Informa	tion t	able. Feature De	scription se	ction. Dev	ice I	-unctional Modes		
1	Applicati	ion and Impleme	ntation se	ction, Po	wer S	Supply Recomme	ndations se	ection, Lay	out s	section, <i>Device a</i>	nd	
	Documentation Support section, and Mechanical, Packaging, and Orderable Information section											
	Removed Ordering Information table, see POA at the end of the data sheet											
	onange out to an age out of the property of th											
	 Changed x-axis of Figure 5 from V_{CC} - Supply Current to V_{CC} - Supply Voltage											
Connected FREQ pin to VIN and removed FREQ pin connection to GND on Figure 18							17					
The datasheet number will be changing.												
Device Family				Change From:			С					
TPS61085-Q1				SLVSAI9		SLVSAI9A						
These changes may be reviewed at the datasheet links provided.												
http://www.ti.com/lit/ds/symlink/tps61085-q1.pdf												
Rea	son f	or Change:										
To more accurately reflect device characteristics.												
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):												
No anticipated impact. This is a specification change announcement only. There are no changes												
		ual device										
Changes to product identification resulting from this notification:												
None.												
Product Affected:												
TPS61085TDGKRQ1												
For questions regarding this notice, e-mails can be sent to the regional contacts shown below								nown below				
ror questions regarding this notice, e-mails can be sent to the regional contacts shown below												

or your local Field Sales Representative.

Location

E-Mail

Location	E-Maii
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com

Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com